

JMTK90N02AN

Description

Features	Applications	RoHS	
• 20V, 90A	Load Switch		
$R_{DS(ON)}$ < 3.6m Ω @ V_{GS} = 4.5V	PWM Application		
$R_{DS(ON)} < 4.9 m\Omega @ V_{GS} = 2.5 V$	Power Management		
Lead free and Green Device Available			
• Excellent R _{DS(ON)} and Low Gate Charge	^{ge} 100% UIS TESTED!		
Lead Free	100% ΔVds TEST	TED!	
D		GOLIN	
G 🎽 S TO-252-3L Top View	G D S Marking and Pin Assignment	Schematic Diagram	

Device MarkingDeviceOutlinePackageReel SizeReel(pcs)Per Carton
(pcs)JMTK90N02AJMTK90N02ANTAPINGTO-252-3L13"250025000

Absolute Maximum Ratings (@ $T_c = 25^{\circ}C$ unless otherwise specified)

Symbol	Parameter		Value	Units
V _{DS}	Drain-to-Source Voltage		20	V
V _{GS}	Gate-to-Source Voltage		±12	V
	Continuous Drain Current	T _C = 25°C	90	A
Ι _D		T _C = 100°C	57	
I _{DM}	Pulsed Drain Current ⁽¹⁾		360	А
E _{AS}	Single Pulsed Avalanche Energy note2		156	mJ
P _D	Power Dissipation	$T_c = 25^{\circ}C$	54	W
$R_{ extsf{ heta}JA}$	Thermal Resistance, Junction to Ambient ⁽²⁾		32	°C/W
$R_{ extsf{ heta}JC}$	Thermal Resistance, Junction to Case ⁽³⁾		2.32	°C/W
T_{J}, T_{STG}	Junction & Storage Temperature Range		-55 to 150	°C



Electrical Characteristics (T_J = 25°C unless otherwise specified)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Off Cha	aracteristics					•
V _{(BR)DSS}	Drain-Source Breakdown Voltage	$I_{\rm D}$ = 250 μ A, V _{GS} = 0V	20	-	-	V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 20V, V _{GS} = 0V	-	-	1.0	μA
I _{GSS}	Gate-Body Leakage Current	$V_{DS} = 0V, V_{GS} = \pm 12V$	-	-	±100	nA
On Cha	racteristics			-		
V _{GS(th)}	Gate Threshold Voltage	V _{DS} = V _{GS} , I _D = 250μA	0.5	0.8	1.0	V
	Static Drain-Source ON-Resistance ⁽³⁾	V _{GS} =4.5V, I _D =30A	-	2.8	3.6	mΩ
R _{DS(ON)}		V _{GS} = 2.5V, I _D =20A	-	3.8	4.9	mΩ
Dynam	ic Characteristics				•	•
C _{iss}	Input Capacitance		-	3476	-	pF
C _{oss}	Output Capacitance	$V_{GS} = 0V, V_{DS} = 10V,$	-	528	-	pF
C _{rss}	Reverse Transfer Capacitance	f = 1MHz	-	464	-	pF
Qg	Total Gate Charge		-	65	-	nC
Q _{gs}	Gate Source Charge	$V_{GS} = 0$ to 8V	-	8	-	nC
Q_{gd}	Gate Drain("Miller") Charge	$V_{\rm DS} = 10V, I_{\rm D} = 30A$	-	12	-	nC
Switch	ing Characteristics		-	•	1	T
t _{d(on)}	Turn-On DelayTime		-	8	-	ns
t _r	Turn-On Rise Time	V _{GS} = 10V, V _{DD} = 10V	-	19	-	ns
t _{d(off)}	Turn-Off DelayTime	I _D = 30A, R _{GEN} = 3Ω	-	73	-	ns
t _f	Turn-Off Fall Time		-	80	-	ns
Drain-S	ource Diode Characteristics and	Max Ratings				
ls	Maximum Continuous Drain to Source Diode Forward Current			-	90	Α
I _{SM}	Maximum Pulsed Drain to Source Diode Forward Current			-	360	Α
V_{SD}	Drain to Source Diode Forward Voltage	V _{GS} = 0V, I _S = 30A	-	-	1.2	V
trr	Reverse Recovery Time	I _F =20A,di/dt =100A/µs	-	16	-	ns
Qrr	Reverse Recovery Charge	$r_F = 20A$, ui/ut = 100A/µS	-	5.6	-	nC

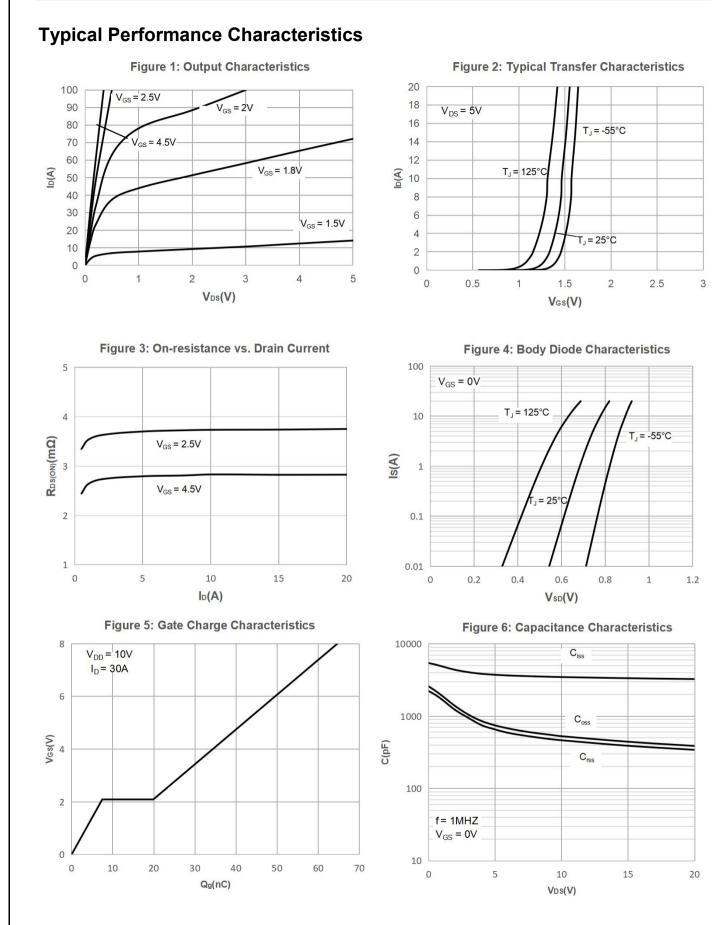
Notes: 1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature.

2. E_{AS} condition: Starting T_J =25 $^\circ\!\!\mathrm{C}$, V_{DD} =10V, V_G =10V, R_G =25 $\Omega,$ L=0.5mH, I_{AS} =25A .

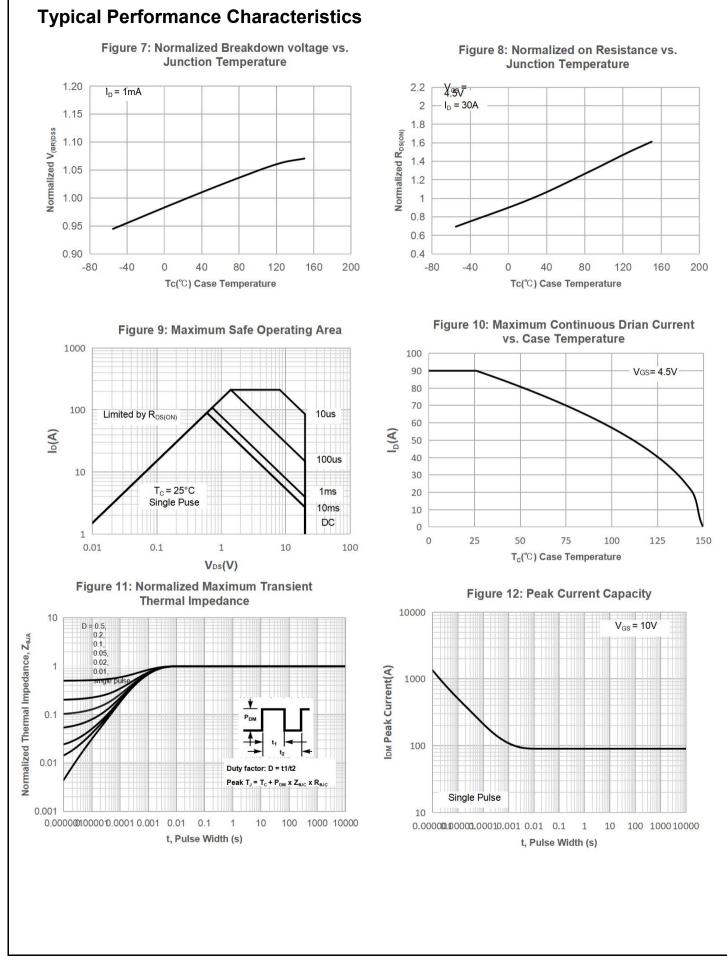
3. $R_{\rm \theta JA}$ is measured with the device mounted on a 1inch^2 pad of 2oz copper FR4 PCB

4. Pulse Test: Pulse Width ${\leqslant}300\mu s,$ Duty Cycle ${\leqslant}0.5\%.$





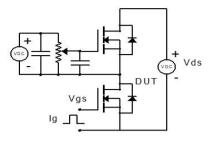






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Test Circuit



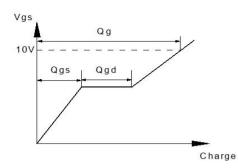


Figure 1: Gate Charge Test Circuit & Waveform

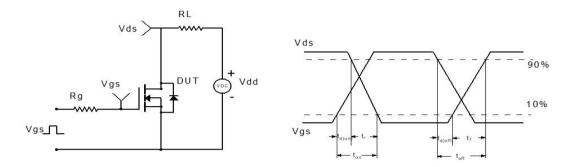


Figure 2: Resistive Switching Test Circuit & Waveform

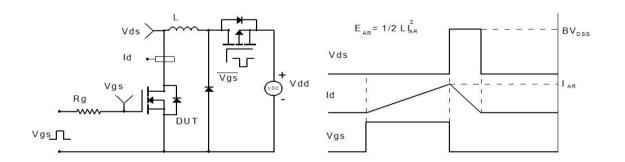
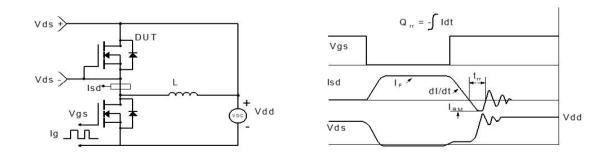
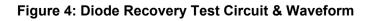


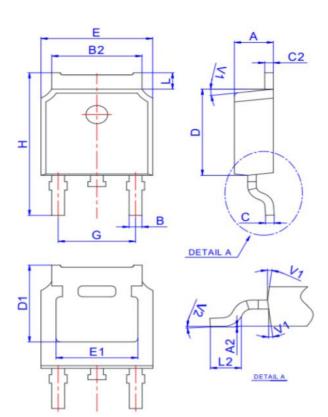
Figure 3: Unclamped Inductive Switching Test Circuit& Waveform







Package Mechanical Data(TO-252-3L)



	Dimensions						
Ref.	Millimeters			Inches			
	Min.	Typ.	Max.	Min.	Тур.	Max.	
Α	2.10		2.50	0.083		0.098	
A2	0		0.10	0		0.004	
В	0.66		0.86	0.026		0.034	
B2	5.18		5.48	0.202		0.216	
С	0.40		0.60	0.016		0.024	
C2	0.44		0.58	0.017		0.023	
D	5.90		6.30	0.232		0.248	
D1	5.30REF			0.209REF			
Е	6.40		6.80	0.252		0.268	
E1	4.63			0.182			
G	4.47		4.67	0.176		0.184	
н	9.50		10.70	0.374		0.421	
L	1.09		1.21	0.043		0.048	
L2	1.35		1.65	0.053		0.065	
V1		7°			7°		
V2	0°		6°	0°		6°	

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